









Release Date: 18 June 2015 Version: A1.0

PRODUCT DATASHEET



- ► PLCC2 SMD
- ➤ 2835 1W Series
- ► Cool White (6500K)

N0W15S56





2835 1W Series





FEATURES:

- Package: PLCC2 High Power White SMT Package
- Forward Current: 120mA Forward Voltage (typ.): 6.4V
- Luminous Flux (typ.): 90lm @120mA
- Colour: Cool White
- Colour Temperature: 6500K
- Viewing angle: 120°
- **Materials:**
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
 - L/T Finish: Ag plated
- Operating Temperature: -20~+80°C Storage Temperature: -30~+100°C
- **Grouping parameters:**
 - Forward voltage
 - Luminous flux
 - **CIE Chromaticity**
- Soldering methods: IR Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 12mm tape with 2000/reel, ø180mm (7")

APPLICATIONS:

- **Decorative Lighting**
- **General Lighting**
- Backlighting
- Indicator
- Display



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	150	mA
Peak Forward Current (Duty 1/10; width 10KHz)	I _{FP}	300	mA
Reverse Current @5V	I _R	50	μΑ
Power Dissipation	P _D	1080	mW
Electrostatic Discharge	ESD	500	V
Junction Temperature	Tj	125	°C
Operating Temperature	T _{OPR}	-20~+80	°C
Storage Temperature	T _{STG}	-30~+100	°C
Soldering Temperature	T _{SD}	260	°C
Colour Rendering Index	CRI	>80	

Electrical & Optical Characteristics (Ta=25°C)

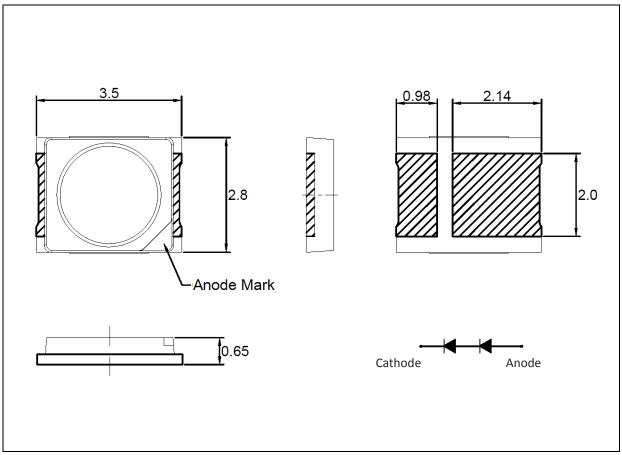
Parameter	Cumbal	Values			Linit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	V_{F}	5.6	6.4	7.2	V	I _F =120mA	
Luminous Flux	Φl _V	80	90	100	lm	I _F =120mA	
Chromaticity	Х	0.3028		0.3221		I _F =120mA	
Coordinates	Υ	0.3113		0.3481			
Colour Temperature	ССТ	6020	6500	7040	К	I _F =120mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =120mA	

- 1. Luminous intensity (I_V) $\pm 15\%$, Forward Voltage (V_F) $\pm 0.1V$, Viewing angle($2\theta_{1/2}$) $\pm 5\%$
- 2. IS standard testing



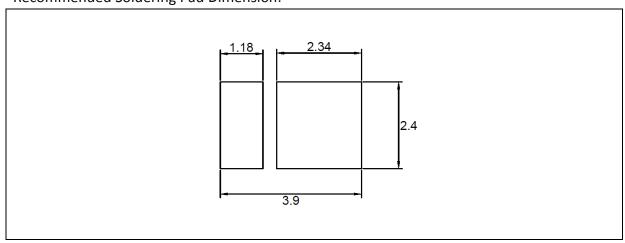
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 120mA):

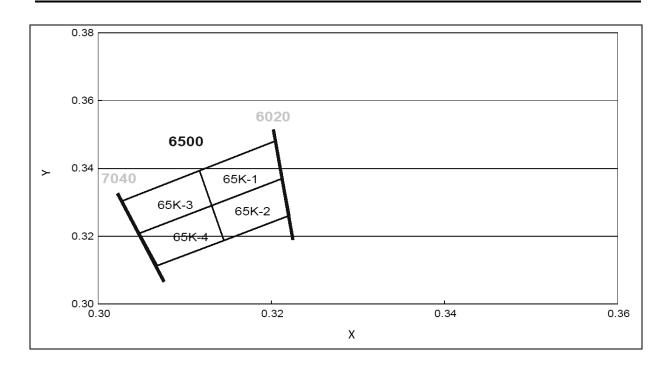
Code	Min.	Max.	Unit
1	5.6	5.8	
2	5.8	6.0	
3	6.0	6.2	
4	6.2	6.4	V
5	6.4	6.6	V
6	6.6	6.8	
7	6.8	7.0	
8	7.0	7.2	

Luminous Flux Classifications (I_F = 120mA):

Code	Min.	Max.	Unit
F80V	80	85	
F85V	85	90	lm
F90V	90	95	lm
F95V	95	100	



CIE CHROMATICITY DIAGRAM:

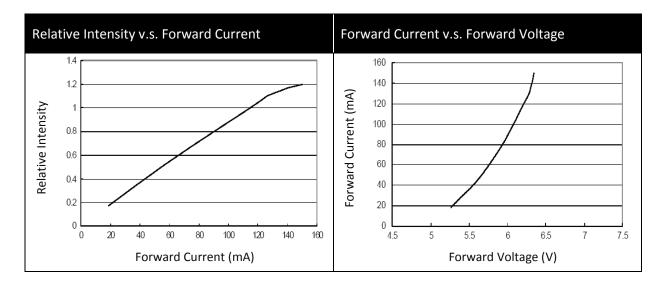


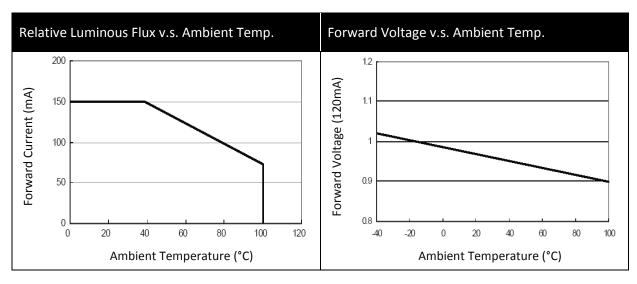
Chromaticity Coordinates Classifications (I_F = 120mA):

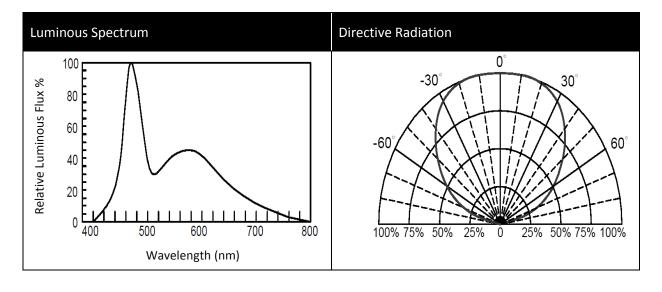
	1	l	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
65K-1	0.3205	0.3481	0.3117	0.3393	0.3131	0.3290	0.3213	0.3371
65K-2	0.3213	0.3371	0.3131	0.3290	0.3145	0.3187	0.3221	0.3261
65K-3	0.3117	0.3393	0.3028	0.3304	0.3048	0.3209	0.3131	0.3290
65K-4	0.3131	0.3290	0.3048	0.3209	0.3068	0.3113	0.3145	0.3187



ELECTRO-OPTICAL CHARACTERISTICS:



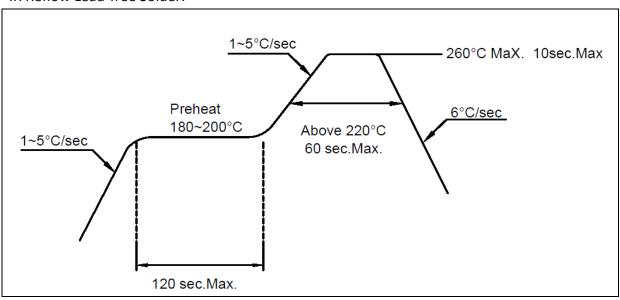






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



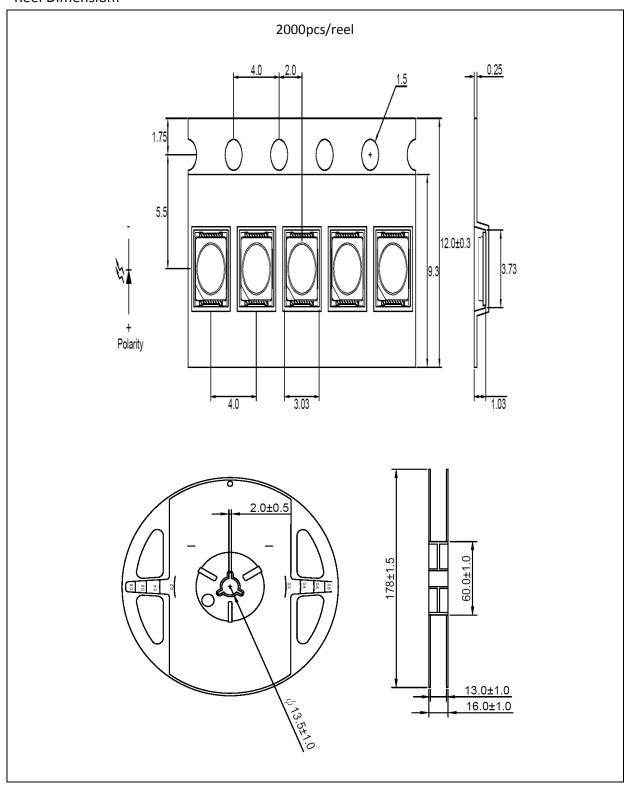
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

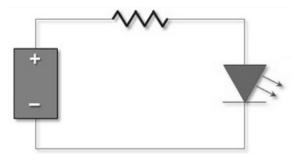
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	26/11/2014	Datasheet set-up.
A1.1	18/06/2015	Revise Anode Mark location.